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UTILITY PATENT APPLICATION TRANSMITTAL <small>(Only for new nonprovisional applications under 37 C.F.R. § 1.53(b).)</small>	Attorney Docket No. C2405
	First Inventor or Application Identifier Takahashi
	Title Electrical Connector with Thermal Sensor
	Express Mail Label No. EL15851775405

APPLICATION ELEMENTS <small>See MPEP chapter 600 concerning utility patent application contents.</small>	ADDRESS TO: Assistant Commissioner for Patents Box Patent Application Washington, DC 20231
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3. <input checked="" type="checkbox"/> Drawing(s) (35 U.S.C. 113) [Total Sheets 6]	ACCOMPANYING APPLICATION PARTS
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TITLE OF THE INVENTION

Electrical Connector With Thermal Sensor

Background of the Invention**1. Field of the Invention**

5 The present invention relates to electrical connectors. Specifically, the present invention relates to an electrical connector with a thermal sensor.

2. Brief Description of Earlier Developments

10 For some time, electronic devices, such as computers, have included connectors to receive electronic cards. The types and capabilities of these electronic cards, such as PC cards defined by the Personal Computer Memory Card International Association (PCMCIA), continue to expand. Future generations of electronic devices will no doubt demand greater performance from the electronic cards.

15 However, the heat generated by use of the PC card, or by the mere use of the electronic device, may be a concern. The heat could impair or even damage the PC card or the electronic device.

Summary of the Invention

20 In consideration of this problem, it is an object of the present invention to provide an electrical connector that can prevent possible impairment of, or damage to, the electronic card or the electronic device due to the heat generated by the electronic card.

25 The present invention is a card connector that supports a PC card in a freely extractable manner and electrically connects the PC card and the electrical device, and is characterized in providing a detection means that detects the surface temperature of the supported PC card and a transmission means that transmits the obtained temperature information

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the electronic card; and transmitting the temperature of the electronic card to the electronic device.

Brief Description of the Drawings

Other uses and advantages of the present invention will become apparent to those skilled in the art upon reference to the specification and the drawings, in which:

Figure 1 is a plan view of the upper surface from arrow I in Figure 3, showing an example of the structure of the card connector according to the present invention;

Figure 2 is an elevational view of the side surface from arrow II in Figure 1, showing an example of the structure of the card connector according to the present invention;

Figure 3 is an elevational view of the side surface from arrow III in Figure 1, showing an example of the structure of the card connector according to the present invention;

Figure 4 is an exploded, perspective view from above showing an example of the structure of the support unit and temperature sensor in the card connector according to the present invention;

Figure 5 is an exploded, elevational view showing, in a pre-assembled state, the support unit and the temperature sensor in the card connector according to the present invention;

Figure 6 is an elevational view, in partial cross-section, of the support unit and temperature sensor in the card connector according to the present invention;

Figure 7 is an exploded, elevational view showing, in a pre-assembled state, the flexible cable and the transition board in the card connector according to the present invention;

Figure 8 is an elevational view showing an example of the connection between the flexible cable and the transition board in the card connector according to the present invention;

Figure 9 is a cross-sectional view, taken along the line IX – IX in

5 Figure 8, showing an example of the connection between the flexible cable and the transition board in the card connector according to the present invention;

Figure 10 is an elevational view from the arrow X in Figure 8 showing an example of the connection between the flexible cable and the transition board in the card connector according to the present invention;

Figure 11 is a perspective view of the hole used for the temperature sensor formed in the cover in the card connector according to the present invention;

Figure 12 is an exploded, elevational view in partial cross-section, showing, in a pre-assembled state, the temperature sensor and the support unit in the card connector according to the present invention; and

Figure 13 is an elevational view, in partial cross-section, showing an example of the installation state of the temperature sensor on the support unit in the card connector according to the present invention.

Detailed Description of the Preferred Embodiments

An example of the structure of the card connector according to the present invention is explained referring to Figure 1 through Figure 3. The card connector 1 is generally structured from a connector frame or body 2, an electrical connector unit 3 formed on one end of the connector body 2 (middle left end in Figure 1), and an eject mechanism 4 formed on the upper surface at one end of the connector body, covers 5 that cover the

connector body 2 above and below, and a temperature sensor (the detection means) 6 installed on the cover 5. Each component of card connector 1 will now be described in more detail below.

The connector body 2 could be a resinous member comprising a pair of parallel arm units 2a and 2b on the left and right, and a base 2c that connects together one end of the arm units 2a and 2b. As shown in Figure 1, frame 2 forms a C-shaped opening towards the other edge. In addition, between arm units 2a and 2b, a space 21 for inserting the electronic card C is formed. On the opposite side surfaces that enclose the arms 2a and 2b and the space 21, upper and lower grooves (not shown) extend in the lengthwise direction of arms 2a and 2b. In addition, two PC cards (upper and lower), can be inserted into the space 21 from the other end side (as shown by arrow S in Figure 1) by being guided by these grooves.

The connection unit 3 could be a typical PC card connector, having on the base 2b a plurality of pins (not shown) arranged along the lengthwise direction of the base 2c. The connector also includes a card bus shield 31 covering these pins from above and below. Finally, the connector 3 could include a transition board 33 (abbreviated "port" hereinbelow) that connects these pins and the card bus shield 31.

On these pins, the upper and lower PC cards C inserted into the space 21 can be respectively independently connected. In addition, the card bus shield 31 contacts the conductive surface of the PC card C inserted into the space 21, and functions as a contact electrode. At the same time, the card bus shield 31 electro-magnetically shields the inside and outside of the PC card. In contrast, the board 33 is a miniature printed circuit board installed along the base 2c, and on its side face, as

shown by reference numeral 33a in Figure 7, a plurality of holes are formed. In these holes 33a, terminals extending from the above pins and the card bus shield 31 are inserted, and fixed by a method such as soldering.

5 In addition, on the lower edge of the board 33, a plurality of connection pads or points 33b used for connecting with the electric device (not shown) are formed along the lengthwise direction of the board 33, as shown in Figure 7. These contact points 33b communicate respectively with the individual holes 33a through known tracing. As a result, the PC
10 card C supported in the card connector 1 connects to an electrical connector (not shown) on the electric device via these contact points 33b.

The eject mechanism 4 releases the PC card C from the card connector 1 in a known manner. The mechanism includes an attach and release mechanism (not shown) for the PC card C, an eject plate 42 on the
15 one arm 2a of the connector body that can move along the arm 2a and engage the other end side of the connector body by a spring 41, and an operation button 43 formed on the other end side of the eject plate 42. In addition, in the case of the present embodiment, on the connector body 2, because an upper and lower PC cards C are inserted, upper and lower
20 injector mechanisms having an identical structure are installed over one another. Other arrangements, such as the mechanisms located on opposite sides, are possible.

The cover 5 is a pair of flat upper and lower conductive members that are respectively supported by the arms 2a and 2b so as to cover from
25 above and below the space 21. The middle of the support unit 5a includes the temperature sensor 6 positioned via the flexible cable 7 (abbreviated "transmission means" hereinafter).

The structure of the support unit 5a and the temperature sensor 6 and the installed state of the temperature sensor on the support unit 5a will be explained using Figure 4 through Figure 6. The support unit 5a is a central portion of the cover 5 that is punched up in a C-shape opening toward both the side on which the eject mechanism 4 is formed and the arm unit 2b on the opposite side. As seen in Figures 4 and 5, the support unit 5a is a formed tongue-shaped member extending in a direction away from the space 21. In addition, the center of the support unit 5a has a hole H therein. The hole H is slightly larger than the size of the temperature sensor 6.

The temperature sensor 6 is installed at one end of the cable 7 so as to protrude into the space 21. Here, the number of wires 71 connecting with the temperature sensor 6 differs depending on the specifications of the temperature sensor. In the case of the present embodiment, a TC74 type sensor made by Telcom Semiconductor could be used. This type of sensor 6 has five wires 71, including three wires 71a for signal transmission and two wires 71b for grounding.

In addition, at one end of the cable 7, a step 7a is formed curved in the cable 7 that extends away the space 21. As a result, the end of the cable 7 is set back away from the space 21.

The temperature sensor 6 is preferably mounted to the support unit 5a as shown in Figure 5. The temperature sensor 6 extends through the hole H1 from the protruding side of the support unit 5a, as shown in Figure 6. The support unit 5a and the end of cable 7 are positioned relative to the space 21 so that the temperature sensor 6 does not interfere with the insertion of PC card C into the space 21, but allows sensor 6 to sense the temperature of the PC card C.

The remainder of the cable is supported on the outer surfaces of the cover 5 and the support unit 5a. In other words, the temperature sensor 6 is installed on support unit 5a so that the side face of the cable 7 abuts the surface of the cover 5 and the support unit 5a. Although the use of adhesive is preferred, any method of securing the cable 7 on the cover 5 and on the support unit 5a could be used.

The cable 7 preferably avoids interference with the eject mechanism 4. As shown in Figure 1, the cable 7 does not interact with arm unit 2a. Rather, cable 7 extends away from the ejector mechanism 4 and extends towards the arm unit 2b on the opposite side. The cable 7 then extends along the length of arm unit 2b to one edge of the connector body 3. In the case of the present embodiment, the double deck connector 1 has two pairs of covers 5. Since each deck of the connector includes a temperature sensor 6, the two cables 7 will overlap as shown by the dotted line in Figure 3. Preferably, tape 8 is used for anchoring the two overlapping cables to the arm unit 2b.

The other end of the cable 7 extends to, and connects with, board 33. The connection state of the cable 7 with the board is explained with reference to Figures 7-10. The board 33 includes holes 33a. As shown in Figure 7, a plurality of holes 33c and 33d are formed for connecting the wires 71 embedded in the cable 7. These holes 33c and 33d respectively communicate with the connection points 33b, like the holes denoted by reference numeral 33a. In the case of the present embodiment, because there are five wires 71 embedded in each cable 7, there are a total of five holes 33c, 33d.

In contrast, the wire 71 are exposed from the other end of the cable 7. At the ends of these wires 71, the terminals are respectively connected.

In addition, as shown in Figures 8 and 9, these terminals 72 are respectively inserted into the corresponding holes 33c and 33d, and anchored by a known method such as welding. Thereby, the cable is connected with the board 33. In the case of the present embodiment, as shown in Figure 10, because there are two cables as described above, the terminal 72 extending from the respective wires are respectively inserted into the corresponding holes 33c and 33d, with the cables overlapping above and below.

In addition, reference numeral 9 denotes leg units formed on the corners of the card connector 1. The card connector is installed into the electric device by a method such as a screw via these legs 9.

In the case of supporting the PC card C in card connector 1, the PC card C is inserted into the space 21 from the other end side of the card connector 1. Thereby, the pins of the connection unit 3 are respectively inserted into the holes (not shown) formed on the distal end of the PC card C, and these pins are connected to the PC card C. At the same time, the card bus shield comes in contact with the surface of the PC card C, and as a result, the PC card C is connected to the electrical device via pins and the terminals 32 extending from the card bus shield 31, the holes 33a in the board 33, and the contact points.

In addition, when the PC card C is inserted into the space 21, the PC card C is supported in the space 21 by the aforementioned release mechanism. Furthermore, along with supporting the PC card C in the card connector 1, the eject plate 42 presses on the other end side of the connector body by the spring 41, and as a result, the operation button 43 protrudes from the other end of the card connector 1, as shown in by reference symbol U in Figures 1-3.

The surface temperature of the PC card C supported by the card connector 1 is detected by the temperature sensor 6. In the case of the present embodiment, on the card connector 1, upper and lower PC cards C can be supported and the surface temperature of the PC card C

5 positioned above is detected by the temperature sensor 6 positioned on the upper side of the cover 5, and the surface temperature of the PC card C positioned below is detected by temperature sensor 6 positioned on the lower side of the cover 5. The result of the detection (temperature information) by the temperatures sensor 6 is transmitted to the electrical
10 device via the wires 71a embedded in the cable 7, the terminals 72, the holes 33d and 33d, and connection point 33b in the board 33. In the electrical device, the results of the detection transmitted from the temperature sensor 6 are continuously monitored, and in the case that the surface temperature of the PC card C reaches a temperature higher
15 than a pre-set temperature, a specified action, such as stopping the current to the PC card C, is carried out.

To extract the PC card C from the card connector 1, the operation button 43 is pressed towards the card connector. Thereby, the eject plate 42 moves to one end of the connector due to the resistance of the spring

20 41. As shown by the line in Figures 1-3, the operation button 43 is pressed into the card connector, and at the same time, the PC card C is supported in the space 21 is pressed from one end side of the connector body 2 by the attachment and release mechanism, and projects from the other end side of the card connector 1.

25 According to the card connector having the above structure, the surface temperature of the PC card C supported by the card connector 1 is detected by the temperature sensor 6, and the detection result is

monitored by the electrical device. Therefore, before the PC card itself and the electrical device possibly suffer deleterious effects due to the heat generation of the PC card C, it is possible to stop the heat generation of the PC card C, and prevent the above deleterious effects.

5 In addition, because the cable 7 extending from the temperature sensor 6 is connected to board 33, the board 33 only connects to the electric device via the contact points 33b, and the connection between the temperature sensor 6 and the electrical device is complete. That is, according to the card connector having the above structure, the temperature sensor 6 can be simply connected to the electrical device via the board 33. No additional contacts on connector 3 are needed.

Moreover, the installation method of the temperature sensor 6 to the card connector 1 is not limited to that shown in Figures 4-6. For example, Figures 11-13 provide an example of installing sensor 6 to

10 connector 1. In Figures 11-13, the center of the cover 5 has a hole H2 slightly larger than the temperature sensor 6. In this hole H2, as shown in Figure 12, the temperature sensor 6 is inserted from the side opposite (the upper center in the figure) the space 21. In other words, this embodiment does not require support unit 5a such as that shown in Figures 4-6. Rather, the cable 7 is provided with spacers 10, one on each side of hole H2. In order to properly position sensor 6, the height of spacer 10 is identical to that of the step 7c in the first embodiment. As seen in Figures 12 and 13, spacers 10 surround the temperature sensor 6 from the front and back.

25 In addition, as shown in Figure 13, the cable 7 and the spacer 10 are supported by the surface of cover 5 using, for example, adhesive. The temperature sensor 6 is positioned on cover 5 so as to protrude towards

the space 21 side from the cover to a degree that does not interfere with the PC card C inserted into the space 21.

In yet another alternative embodiment, such as when connector 1 lacks cover 5, it is possible to install some sort of support body (not shown) over the space 21. A temperature sensor 6 is installed on the support body facing the space 21.

Although the above description provides a double deck connector 1, the number of the PC cards C supported by the card connector is not limited to an upper and lower card. The connector could accept one PC card, or more than two PC cards. Furthermore, the technique of the present invention can be applied not only to what is called a card-bus-type card connector, but may be applied to a card connector without a card bus shield as well.

In addition, for the temperature sensor 6, any well-known thermometer, such as a thermoelectric thermometer, a resistance thermometer, or a radiation thermometer, can be used if thermometer can transmit the detection results as an electric signal.

As explained above, according to the card connector of the present invention, because the surface temperature of the PC card supported in the card connector is detected by a detection means, and the obtained temperature information is monitored in the electronic device, it is possible to stop the heat generation of the PC card before the PC card itself and the electric device suffer deleterious effects due to heat generation by the PC card, and thus this deleterious influence can be prevented.

In addition, in the case that the transmission means transmitting the temperature information from the detection means to the electronic

device has a structure wherein this temperature information is transmitted to the electronic device via the transition board of the card connector, because the connection between the detection means and the electronic device is completed with only the connection of the transition board to the electronic device, the detection means and the electronic device can be easily connected.

While the present invention has been described in connection with the preferred embodiments of the various figures, it is to be understood that other similar embodiments may be used or modifications and additions may be made to the described embodiment for performing the same function of the present invention without deviating therefrom. Therefore, the present invention should not be limited to any single embodiment, but rather construed in breadth and scope in accordance with the recitation of the appended claims.

Claims**WHAT IS CLAIMED IS:**

1. An electrical connector system, comprising:
an electrical connector adapted to receive a mating connector; and
5 a temperature sensor on said electrical connector for detecting a
temperature of the mating connector.

2. The electrical connector system as recited in claim 1, wherein the
electrical connector includes an opening for receiving the mating
10 connector, said temperature sensor extending into said opening.

3. The electrical connector system as recited in claim 1, wherein said
electrical connector comprises an electronic card connector.

4. The electrical connector system as recited in claim 3, wherein said
electronic card connector includes a conductive cover having an aperture
therein, said temperature sensor extending into said aperture.

5. The electrical connector system as recited in claim 4, wherein said
20 cover includes a tab associated with said aperture, said temperature
sensor mounted to said tab.

6. The electrical connector system as recited in claim 5, further
comprising an eject mechanism for extracting the mating connector.

25 7. The electrical connector system as recited in claim 6, wherein said
temperature sensor remains a distance away from said eject mechanism.

9. An electrical connector for an electronic card, comprising:

- a header;
- a frame associated with said header to guide the electronic card into engagement with said header; and
- a temperature sensor associated with said frame to detect a temperature of the electronic card.

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14. The electrical connector system as recited in claim 9, further

comprising a flexible circuit, said temperature sensor mounted to said flexible circuit.

15. The electrical connector system as recited in claim 14, wherein said
5 flexible circuit extends along said frame.

16. An electrical connector system for an electronic card, comprising:
an electrical connector;

a frame associated with said electrical connector;

10 a temperature sensor associated with said frame to detect a
temperature of the mating connector; and

a transition board, said electrical connector and said temperature
sensor connected to said transition board.

15 17. The electrical connector system as recited in claim 16, wherein said
connector and said temperature are discretely connected to said
transition board.

18. The electrical connector system as recited in claim 16, further
20 comprising a flexible circuit secured to said transition board, said
temperature sensor mounted to said flexible circuit.

19. The electrical connector system as recited in claim 18, wherein said
flexible circuit extends along said frame.

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20. A method of monitoring a temperature of an electronic card in an
electrical connector mounted to an electronic device, comprising the steps

of:

sensing the temperature of the electronic card; and

transmitting the temperature of the electronic card to the electronic device.

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21. The method as recited in claim 20, wherein the electronic card communicates with the electronic device through the connector, said transmitting step independent of the communications between the connector and the electronic device.

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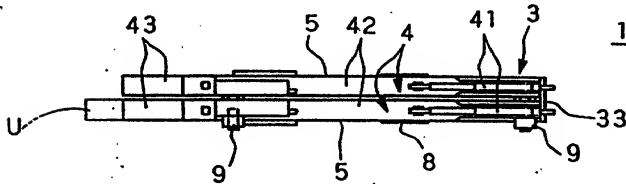
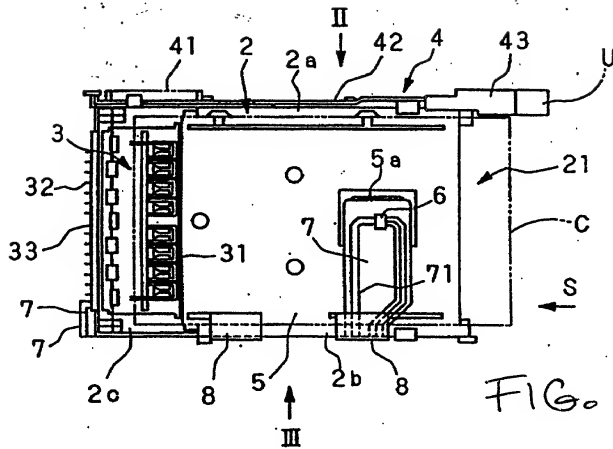
22. The method as recited in claim 20, wherein the connector includes a transition board, said transmitting step occurring through the transition board.

15

Abstract

A card connector system that detachably supports a PC card and electrically connects the PC card to an electrical device. The system includes a temperature sensor to monitor temperature of the PC card to prevent the deleterious effect of heat generated by the PC card on the PC card itself and the electrical device. The sensor detects the surface temperature of the supported PC card and transmits the obtained temperature information to the electrical device. In this case, it is preferable that a transition board 33, electrically connected between the PC card and the electrical device, is used to transmit the temperature information.

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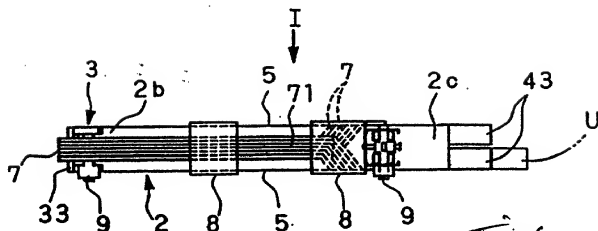


FIG. 3

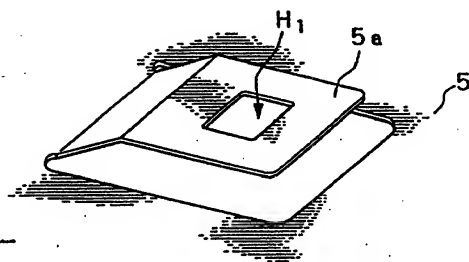
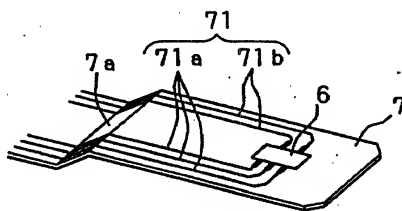


FIG. 4

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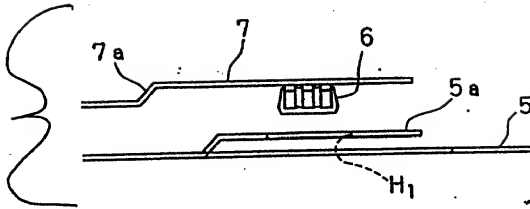


FIG. 5

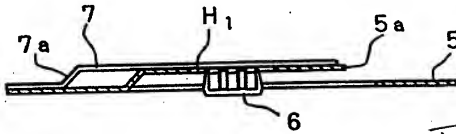


FIG. 6

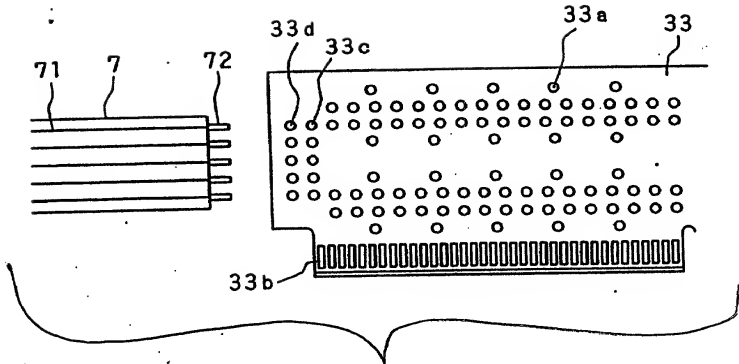


FIG. 7

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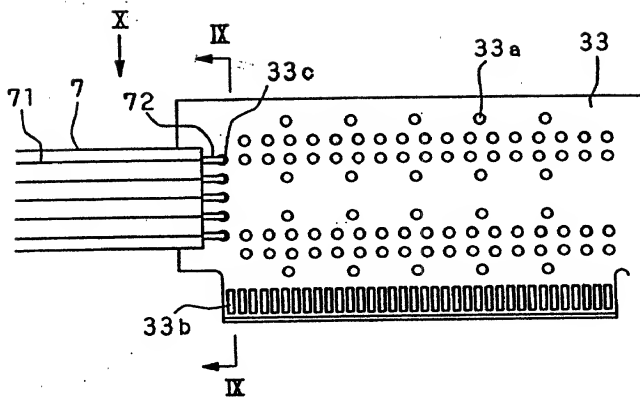


FIG. 8

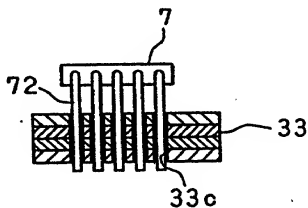


FIG. 9

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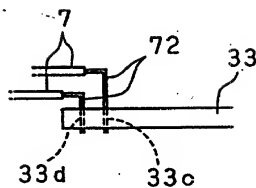


FIG. 10

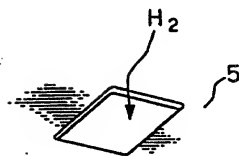


FIG. 11

[illegible]

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DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

☒ Declaration Submitted with Initial Filing OR ☐ Declaration Submitted after Initial Filing (surcharge (37 CFR 1.16 (e)) required)

Attorney Docket Number **C2405**

First Named Inventor **Takahashi**

COMPLETE IF KNOWN

Application Number **/**

Filing Date

Group Art Unit

Examiner Name

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

ELECTRICAL CONNECTOR WITH THERMAL SENSOR

the specification of which (Title of the Invention)

☒ is attached hereto

OR

☐ was filed on (MM/DD/YYYY) as United States Application Number or PCT International

Application Number and was amended on (MM/DD/YYYY) (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Not Claimed	Certified Copy Attached? YES NO
11-229472	JP	08/13/1999	<input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>	<input checked="" type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

☐ Additional foreign application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto.

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Application Number(s)	Filing Date (MM/DD/YYYY)	
		<input type="checkbox"/> Additional provisional application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto.

[Page 1 of 2]

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I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT International application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

U.S. Parent Application or PCT Parent Number	Parent Filing Date (MM/DD/YYYY)	Parent Patent Number (if applicable)

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Name of Sole or First Inventor:		<input type="checkbox"/> A petition has been filed for this unsigned inventor	
Given Name (first and middle (if any))		Family Name or Surname	
Ryosuke		Takahashi	
Inventor's Signature		Date	
Residence: City	State	Country	Citizenship
Post Office Address			
Post Office Address			
City	State	ZIP	Country

☐ Additional inventors are being named on the supplemental Additional Inventor(s) sheet(s) PTO/SB/02A attached hereto